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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

| Details | |
|----------------------------|--|
| Product Status | Active |
| Core Processor | R8C |
| Core Size | 16-Bit |
| Speed | 20MHz |
| Connectivity | I ² C, LINbus, SIO, SSU, UART/USART |
| Peripherals | POR, PWM, Voltage Detect, WDT |
| Number of I/O | 71 |
| Program Memory Size | 48KB (48K x 8) |
| Program Memory Type | FLASH |
| EEPROM Size | - |
| RAM Size | 2.5K x 8 |
| Voltage - Supply (Vcc/Vdd) | 2.2V ~ 5.5V |
| Data Converters | A/D 20x10b; D/A 2x8b |
| Oscillator Type | Internal |
| Operating Temperature | -40°C ~ 85°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 80-LQFP |
| Supplier Device Package | 80-LQFP (12x12) |
| Purchase URL | https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f212d7sdfp-v2 |

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1.1.2 Specifications

Tables 1.1 and 1.2 outlines the Specifications for R8C/2C Group and Tables 1.3 and 1.4 outlines the Specifications for R8C/2D Group.

Table 1.1 Specifications for R8C/2C Group (1)

| Item | Function | Specification |
|----------------------|--------------------|---|
| CPU | Central processing | R8C/Tiny series core |
| | unit | Number of fundamental instructions: 89 |
| | | Minimum instruction execution time: |
| | | 50 ns (f(XIN) = 20 MHz, VCC = 3.0 to 5.5 V) |
| | | 100 ns (f(XIN) = 10 MHz, VCC = 2.7 to 5.5 V) |
| | | 200 ns (f(XIN) = 5 MHz, VCC = 2.2 to 5.5 V) |
| | | Multiplier: 16 bits × 16 bits → 32 bits |
| | | Multiply-accumulate instruction: 16 bits x 16 bits + 32 bits → 32 bits |
| | | Operation mode: Single-chip mode (address space: 1 Mbyte) |
| Memory | ROM, RAM | Refer to Table 1.5 Product List for R8C/2C Group. |
| Power Supply | Voltage detection | Power-on reset |
| Voltage Detection | circuit | Voltage detection 3 |
| I/O Ports | Programmable I/O | Input-only: 2 pins |
| 1,01010 | ports | CMOS I/O ports: 71, selectable pull-up resistor |
| | Porto | High current drive ports: 8 |
| Clock | Clock generation | 3 circuits: XIN clock oscillation circuit (with on-chip feedback resistor), |
| Clock | circuits | On-chip oscillator (high-speed, low-speed) |
| | onouno | (high-speed on-chip oscillator has a frequency adjustment function), |
| | | XCIN clock oscillation circuit (32 kHz) |
| | | Oscillation stop detection: XIN clock oscillation stop detection function |
| | | • Frequency divider circuit: Dividing selectable 1, 2, 4, 8, and 16 |
| | | • Low power consumption modes: |
| | | Standard operating mode (high-speed clock, low-speed clock, high-speed |
| | | on-chip oscillator, low-speed on-chip oscillator), wait mode, stop mode |
| | | Real-time clock (timer RE) |
| Interrupts | | External: 5 sources, Internal: 23 sources, Software: 4 sources |
| | | Priority levels: 7 levels |
| Watchdog Time | er | 15 bits × 1 (with prescaler), reset start selectable |
| Timer | Timer RA | 8 bits × 1 (with 8-bit prescaler) |
| | | Timer mode (period timer), pulse output mode (output level inverted every |
| | | period), event counter mode, pulse width measurement mode, pulse period |
| | | measurement mode |
| | Timer RB | 8 bits x 1 (with 8-bit prescaler) |
| | | Timer mode (period timer), programmable waveform generation mode (PWM |
| | | output), programmable one-shot generation mode, programmable wait one- |
| | | shot generation mode |
| | Timer RC | 16 bits × 1 (with 4 capture/compare registers) |
| | | Timer mode (input capture function, output compare function), PWM mode |
| | T 00 | (output 3 pins), PWM2 mode (PWM output pin) |
| | Timer RD | 16 bits × 2 (with 4 capture/compare registers) Timer mode (input capture function, output compare function), PWM mode |
| | | (output 6 pins), reset synchronous PWM mode (output three-phase |
| | | waveforms (6 pins), sawtooth wave modulation), complementary PWM mode |
| | | (output three-phase waveforms (6 pins), triangular wave modulation), PWM3 |
| | | |
| | Timer RE | mode (PWM output 2 pins with fixed period) |
| | Tillel KE | 8 bits × 1 Real-time clock mode (count seconds, minutes, hours, days of week), output |
| | | compare mode |
| | Timer RF | 16 bits × 1 (with capture/compare register pin and compare register pin) |
| | | Input capture mode, output compare mode |



1.2 Product List

Table 1.5 lists Product List for R8C/2C Group, Figure 1.1 shows a Part Number, Memory Size, and Package of R8C/2C Group, Table 1.6 lists Product List for R8C/2D Group, and Figure 1.2 shows a Part Number, Memory Size, and Package of R8C/2D Group.

Table 1.5 Product List for R8C/2C Group

Current of Dec. 2007

| Part No. | ROM Capacity | RAM Capacity | Package Type | Re | marks |
|-----------------|--------------|--------------|--------------|-----------|------------------------|
| R5F212C7SNFP | 48 Kbytes | 2.5 Kbytes | PLQP0080KB-A | N version | |
| R5F212C8SNFP | 64 Kbytes | 3 Kbytes | PLQP0080KB-A |] | |
| R5F212CASNFP | 96 Kbytes | 7 Kbytes | PLQP0080KB-A |] | |
| R5F212CCSNFP | 128 Kbytes | 7.5 Kbytes | PLQP0080KB-A | | |
| R5F212C7SDFP | 48 Kbytes | 2.5 Kbytes | PLQP0080KB-A | D version | |
| R5F212C8SDFP | 64 Kbytes | 3 Kbytes | PLQP0080KB-A |] | |
| R5F212CASDFP | 96 Kbytes | 7 Kbytes | PLQP0080KB-A | | |
| R5F212CCSDFP | 128 Kbytes | 7.5 Kbytes | PLQP0080KB-A |] | |
| R5F212C7SNXXXFP | 48 Kbytes | 2.5 Kbytes | PLQP0080KB-A | N version | Factory |
| R5F212C8SNXXXFP | 64 Kbytes | 3 Kbytes | PLQP0080KB-A | | programming |
| R5F212CASNXXXFP | 96 Kbytes | 7 Kbytes | PLQP0080KB-A | | product ⁽¹⁾ |
| R5F212CCSNXXXFP | 128 Kbytes | 7.5 Kbytes | PLQP0080KB-A |] | |
| R5F212C7SDXXXFP | 48 Kbytes | 2.5 Kbytes | PLQP0080KB-A | D version | |
| R5F212C8SDXXXFP | 64 Kbytes | 3 Kbytes | PLQP0080KB-A | | |
| R5F212CASDXXXFP | 96 Kbytes | 7 Kbytes | PLQP0080KB-A | | |
| R5F212CCSDXXXFP | 128 Kbytes | 7.5 Kbytes | PLQP0080KB-A | | |

NOTE:

^{1.} The user ROM is programmed before shipment.

Table 1.6 Product List for R8C/2D Group

Current of Dec. 2007

| Part No. | ROM C | apacity | RAM | Package Type | D/ | emarks |
|-----------------|-------------|-------------|------------|--------------|-----------|------------------------|
| Fait No. | Program ROM | Data flash | Capacity | Fackage Type | INC. | illaiks |
| R5F212D7SNFP | 48 Kbytes | 1 Kbyte x 2 | 2.5 Kbytes | PLQP0080KB-A | N version | |
| R5F212D8SNFP | 64 Kbytes | 1 Kbyte x 2 | 3 Kbytes | PLQP0080KB-A | | |
| R5F212DASNFP | 96 Kbytes | 1 Kbyte x 2 | 7 Kbytes | PLQP0080KB-A | | |
| R5F212DCSNFP | 128 Kbytes | 1 Kbyte x 2 | 7.5 Kbytes | PLQP0080KB-A | | |
| R5F212D7SDFP | 48 Kbytes | 1 Kbyte x 2 | 2.5 Kbytes | PLQP0080KB-A | D version | |
| R5F212D8SDFP | 64 Kbytes | 1 Kbyte x 2 | 3 Kbytes | PLQP0080KB-A | | |
| R5F212DASDFP | 96 Kbytes | 1 Kbyte x 2 | 7 Kbytes | PLQP0080KB-A | | |
| R5F212DCSDFP | 128 Kbytes | 1 Kbyte x 2 | 7.5 Kbytes | PLQP0080KB-A | | |
| R5F212D7SNXXXFP | 48 Kbytes | 1 Kbyte x 2 | 2.5 Kbytes | PLQP0080KB-A | N version | Factory |
| R5F212D8SNXXXFP | 64 Kbytes | 1 Kbyte x 2 | 3 Kbytes | PLQP0080KB-A | | programming |
| R5F212DASNXXXFP | 96 Kbytes | 1 Kbyte x 2 | 7 Kbytes | PLQP0080KB-A | | product ⁽¹⁾ |
| R5F212DCSNXXXFP | 128 Kbytes | 1 Kbyte x 2 | 7.5 Kbytes | PLQP0080KB-A | | |
| R5F212D7SDXXXFP | 48 Kbytes | 1 Kbyte x 2 | 2.5 Kbytes | PLQP0080KB-A | D version | |
| R5F212D8SDXXXFP | 64 Kbytes | 1 Kbyte x 2 | 3 Kbytes | PLQP0080KB-A | | |
| R5F212DASDXXXFP | 96 Kbytes | 1 Kbyte x 2 | 7 Kbytes | PLQP0080KB-A | | |
| R5F212DCSDXXXFP | 128 Kbytes | 1 Kbyte x 2 | 7.5 Kbytes | PLQP0080KB-A | | |

NOTE:

1. The user ROM is programmed before shipment.

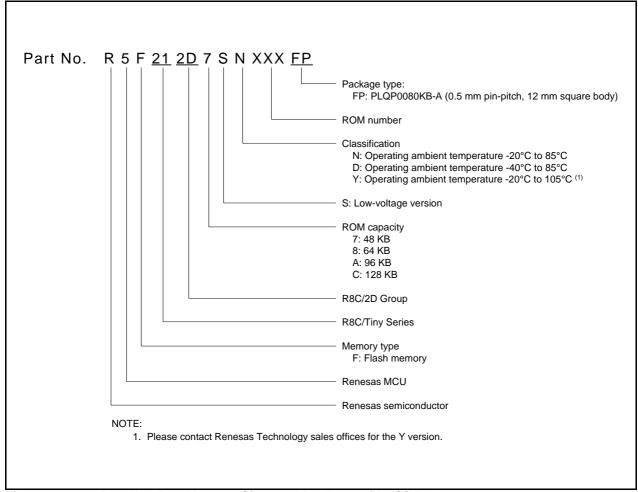


Figure 1.2 Part Number, Memory Size, and Package of R8C/2D Group

1.4 Pin Assignment

Figure 1.4 shows Pin Assignment (Top View). Tables 1.7 and 1.8 outlines the Pin Name Information by Pin Number.

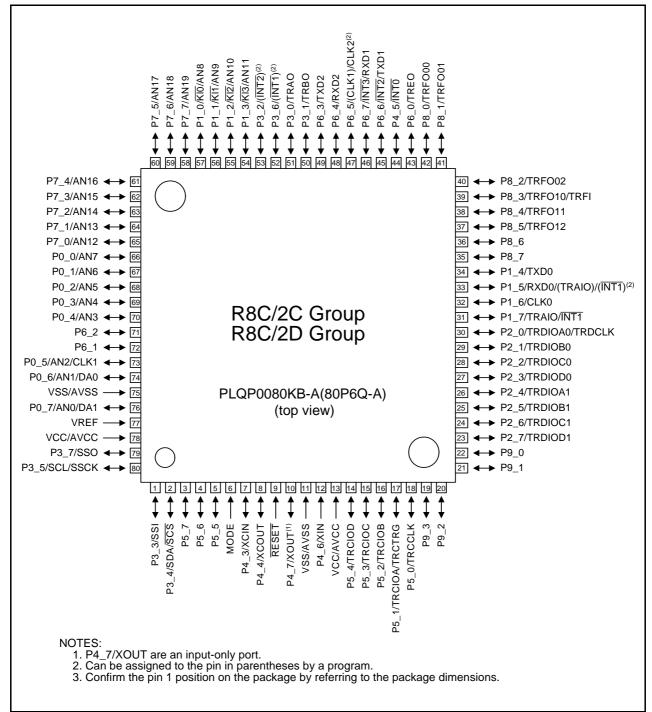


Figure 1.4 Pin Assignment (Top View)

Pin Name Information by Pin Number (2) Table 1.8

| Die | | | I/O Pin Functions for of Peripheral Modules | | | | | | | |
|---------------|-------------|------|---|-------|--------------------------------|------|----------------------|---------------------------------|--|--|
| Pin Number | Control Pin | Port | Interrupt | Timer | Serial Interface | SSU | I ² C bus | A/D Converter, D/A Converter | | |
| 46 | | P6_7 | ĪNT3 | | RXD1 | | | | | |
| 47 | | P6_5 | | | (CLK1) ⁽¹⁾ /CLK2 | | | | | |
| 48 | | P6_4 | | | RXD2 | | | | | |
| 49 | | P6_3 | | | TXD2 | | | | | |
| 50 | | P3_1 | | TRBO | | | | | | |
| 51 | | P3_0 | | TRAO | | | | | | |
| 52 | | P3_6 | (INT1) ⁽¹⁾ | | | | | | | |
| 53 | | P3_2 | (INT2) ⁽¹⁾ | | | | | | | |
| 54 | | P1_3 | KI3 | | | | | AN11 | | |
| 55 | | P1_2 | KI2 | | | | | AN10 | | |
| 56 | | P1_1 | KI1 | | | | | AN9 | | |
| 57 | | P1_0 | KI0 | | | | | AN8 | | |
| 58 | | P7_7 | | | | | | AN19 | | |
| 59 | | P7_6 | | | | | | AN18 | | |
| 60 | | P7_5 | | | | | | AN17 | | |
| 61 | | P7_4 | | | | | | AN16 | | |
| 62 | | P7_3 | | | | | | AN15 | | |
| 63 | | P7_2 | | | | | | AN14 | | |
| 64 | | P7_1 | | | | | | AN13 | | |
| 65 | | P7_0 | | | | | | AN12 | | |
| 66 | | P0_0 | | | | | | AN7 | | |
| 67 | | P0_1 | | | | | | AN6 | | |
| 68 | | P0_2 | | | | | | AN5 | | |
| 69 | | P0_3 | | | | | | AN4 | | |
| 70 | | P0_4 | | | | | | AN3 | | |
| 71 | | P6_2 | | | | | | | | |
| 72 | | P6_1 | | | | | | | | |
| 73 | | P0_5 | | | CLK1 | | | AN2 | | |
| 74 | | P0_6 | | | | | | AN1/DA0 | | |
| 75 | VSS/AVSS | | | | | | | | | |
| 76 | | P0_7 | | | | | | AN0/DA1 | | |
| 77 | VREF | | | | | | | | | |
| 78 | VCC/AVCC | | | | | | | | | |
| 79 | | P3_7 | | | | SSO | | | | |
| 80 | | P3_5 | | | | SSCK | SCL | | | |

NOTE:

1. Can be assigned to the pin in parentheses by a program.

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU Registers. The CPU contains 13 registers. R0, R1, R2, R3, A0, A1, and FB configure a register bank. There are two sets of register bank.

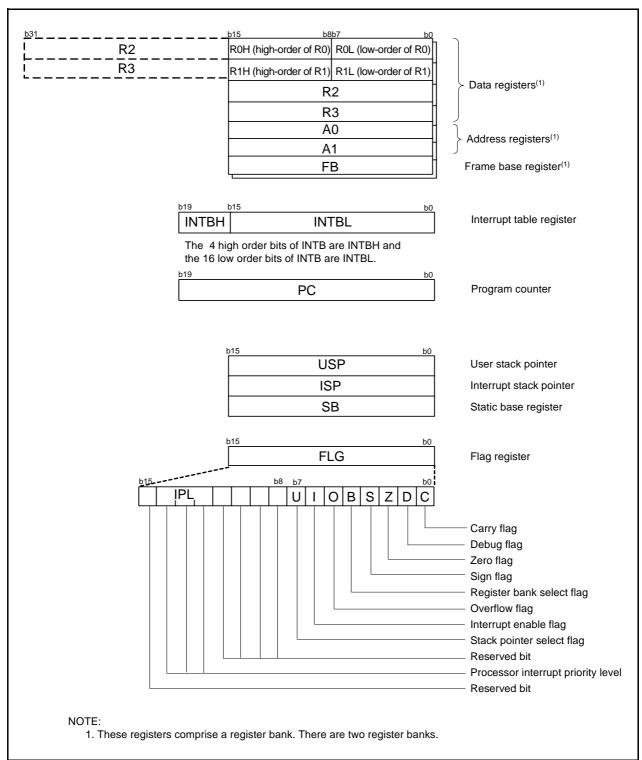


Figure 2.1 CPU Registers

SFR Information (2)⁽¹⁾ Table 4.2

| A d drago | Dowleton | Cumhal | After react |
|-------------------------|---|---------------|------------------------|
| Address | Register | Symbol | After reset |
| 0040h | | | |
| 0041h | | | |
| 0042h | | | |
| 0043h | | | |
| 0044h | | | |
| 0045h | | | |
| 0046h | | | |
| 0047h | Timer RC Interrupt Control Register | TRCIC | XXXXX000b |
| 0048h | Timer RD0 Interrupt Control Register | TRD0IC | XXXXX000b |
| 0049h | Timer RD1 Interrupt Control Register | TRD1IC | XXXXX000b |
| 004Ah | Timer RE Interrupt Control Register | TREIC | XXXXX000b |
| 004Bh | UART2 Transmit Interrupt Control Register | S2TIC | XXXXX000b |
| 004Ch | UART2 Receive Interrupt Control Register | S2RIC | XXXXX000b |
| 004Dh | Key Input Interrupt Control Register | KUPIC | XXXXX000b |
| 004Eh | | | |
| 004Fh | SSU/IIC Interrupt Control Register ⁽²⁾ | SSUIC / IICIC | XXXXX000b |
| 0050h | Compare 1 Interrupt Control Register | CMP1IC | XXXXX000b |
| 0051h | UART0 Transmit Interrupt Control Register | SOTIC | XXXXX000b |
| 0051h | UARTO Receive Interrupt Control Register | SORIC | XXXXX000b XXXXX000b |
| 0052h | UART1 Transmit Interrupt Control Register | S1TIC | XXXXX000b |
| 0053h | UART1 Receive Interrupt Control Register | S1RIC | XXXXX000b |
| 0054H | INT2 Interrupt Control Register | INT2IC | XX00X000b |
| 0056h | Timer RA Interrupt Control Register | TRAIC | XXXXXX000b |
| | Timer NA interrupt Control Register | IRAIC | ^^^^0 |
| 0057h | Times DD Interview Control D | TDDIO | VVVVV000b |
| 0058h | Timer RB Interrupt Control Register | TRBIC | XXXXX000b |
| 0059h | INT1 Interrupt Control Register | INT1IC | XX00X000b |
| 005Ah | INT3 Interrupt Control Register | INT3IC | XX00X000b |
| 005Bh | Timer RF Interrupt Control Register | TRFIC | XXXXX000b |
| 005Ch | Compare 0 Interrupt Control Register | CMP0IC | XXXXX000b |
| 005Dh | INT0 Interrupt Control Register | INT0IC | XX00X000b |
| 005Eh | A/D Conversion Interrupt Control Register | ADIC | XXXXX000b |
| 005Fh | Capture Interrupt Control Register | CAPIC | XXXXX000b |
| 0060h | | | |
| 0061h | | | |
| 0062h | | | |
| 0063h | | | |
| 0064h | | | |
| 0065h | | | |
| 0066h | | | |
| 0067h | | | |
| 0068h | | | |
| 0069h | | | |
| 006Ah | | | |
| 006Bh | | | |
| 006Ch | | | |
| 006Dh | | | |
| 006Eh | | | |
| 006Fh | | | |
| 000111 0070h | | | |
| 0070H | | | |
| 007111 0072h | | | |
| 0072h | | | |
| 0073h | | | |
| | | | |
| 0075h | | | |
| 0076h | | | |
| 0077h | | | |
| 0078h | | | |
| 0079h | | | |
| | | 1 | 1 |
| 007Ah | | | |
| 007Bh | | | |
| 007Bh 007Ch | | | |
| 007Bh 007Ch 007Dh | | | |
| 007Bh 007Ch | | | |

- X: Undefined
 NOTES:

 1. The blank regions are reserved. Do not access locations in these regions.
 2. Selected by the IICSEL bit in the PMR register.

SFR Information (4)⁽¹⁾ Table 4.4

| Address | Register | Symbol | After reset |
|---------|---|--------|-------------|
| 00C0h | | j | |
| 00C1h | | | |
| 00C2h | | | |
| 00C3h | | | |
| 00C3h | | | |
| | | | |
| 00C5h | | | |
| 00C6h | | | |
| 00C7h | | | |
| 00C8h | | | |
| 00C9h | | | |
| 00CAh | | | |
| 00CBh | | | |
| 00CCh | | | |
| 00CDh | | | |
| 00CEh | | | |
| 00CFh | | | |
| | | | |
| 00D0h | | | |
| 00D1h | | | |
| 00D2h | | | |
| 00D3h | | | |
| 00D4h | | | |
| 00D5h | | | |
| 00D6h | | | |
| 00D7h | | | |
| 00D8h | D/A Register 0 | DA0 | 00h |
| 00D0h | D// (register o | Brio | 0011 |
| 00D9H | D/A Pogistor 1 | DA1 | 00h |
| | D/A Register 1 | DA1 | OUN |
| 00DBh | | | |
| 00DCh | D/A Control Register | DACON | 00h |
| 00DDh | | | |
| 00DEh | | | |
| 00DFh | | | |
| 00E0h | Port P0 Register | P0 | XXh |
| 00E1h | Port P1 Register | P1 | XXh |
| 00E2h | Port P0 Direction Register | PD0 | 00h |
| 00E3h | Port P1 Direction Register | PD1 | 00h |
| 00E3h | Port P2 Parieter | P2 | |
| | Port P2 Register | | XXh |
| 00E5h | Port P3 Register | P3 | XXh |
| 00E6h | Port P2 Direction Register | PD2 | 00h |
| 00E7h | Port P3 Direction Register | PD3 | 00h |
| 00E8h | Port P4 Register | P4 | XXh |
| 00E9h | Port P5 Register | P5 | XXh |
| 00EAh | Port P4 Direction Register | PD4 | 00h |
| 00EBh | Port P5 Direction Register | PD5 | 00h |
| 00ECh | Port P6 Register | P6 | XXh |
| 00EDh | 1 or 1 o register | 10 | 77311 |
| | Part DC Direction Pagistar | DDC | 006 |
| 00EEh | Port P6 Direction Register | PD6 | 00h |
| 00EFh | | | |
| 00F0h | | | |
| 00F1h | | | |
| 00F2h | | | |
| 00F3h | | | |
| 00F4h | Port P2 Drive Capacity Control Register | P2DRR | 00h |
| 00F5h | UART1 Function Select Register | U1SR | 000000XXb |
| 00F6h | | 31810 | 0000007010 |
| 00F7h | | | |
| | Deat Made Desistes | DMD | OOL |
| 00F8h | Port Mode Register | PMR | 00h |
| 00F9h | External Input Enable Register | INTEN | 00h |
| 00FAh | INT Input Filter Select Register | INTF | 00h |
| 00FBh | Key Input Enable Register | KIEN | 00h |
| 00FCh | Pull-Up Control Register 0 | PUR0 | 00h |
| 00FDh | Pull-Up Control Register 1 | PUR1 | XX000000b |
| | | 1, 2, | |
| 00FEh | | | |

X: Undefined
NOTE:

1. The blank regions are reserved. Do not access locations in these regions.

SFR Information (8)⁽¹⁾ Table 4.8

| Address | Register | Symbol | After reset |
|----------------|----------|--------|-------------|
| 01C0h | | | |
| 01C1h | | | |
| 01C2h | | | |
| 01C3h | | | |
| 01C4h | | | |
| 01C5h | | | |
| 01C6h | | | |
| 01C7h | | | |
| 01C8h | | | |
| 01C9h | | | |
| 01CAh | | | |
| 01CAII | | | |
| 01CCh | | | |
| 01CCh | | | |
| 01000 | | | |
| 01CEh | | | |
| 01CFh | | | |
| 01D0h | | | |
| 01D1h | | | |
| 01D2h | | | |
| 01D3h | | | |
| 01D4h | | | |
| 01D5h | | | |
| 01D6h | | | |
| 01D7h | | | |
| 01D8h | | | |
| 01D9h | | | |
| 01DAh | | | |
| 01DBh | | | |
| 01DCh | | | |
| 01DDh | | | |
| 01DEh | | | |
| 01DFh | | | |
| 01E0h | | | |
| 01E1h | | | |
| 01E2h | | | |
| 01E3h | | | |
| 01E4h | | | |
| 01E5h | | | |
| 01E6h | | | |
| 01E7h | | | |
| 01E8h | | | |
| 01E9h | | | |
| 01EAh | | | |
| 01EBh | | | |
| 01ECh | | | |
| 01EDh | | | |
| 01EEh | | | |
| 01EFh | | | |
| 01F0h | | | |
| 01F1h | | | |
| 01F111 | | | |
| | | | |
| 01F3h 01F4h | | | |
| 01F4h 01F5h | | | |
| 01F5h | | | |
| 01500 | | | |
| 01F7h | | | |
| 01F8h | | | |
| 01F9h | | | |
| 01FAh | | | |
| 01FBh | | | |
| 01FCh | | | |
| 01FDh | | | |
| 01FEh | | | |
| 01FFh | | | |
| | | | |

NOTE:

1. The blank regions are reserved. Do not access locations in these regions.

SFR Information (11)⁽¹⁾ **Table 4.11**

| Address | Register | Symbol | After reset |
|-----------------|--|----------|----------------------|
| 0280h | Negistei | Symbol | Aiter reset |
| 0281h | | | |
| | | | |
| 0282h | | | |
| 0283h | | | |
| 0284h | | | |
| 0285h | | | |
| 0286h | | | |
| 0287h | | | |
| 0288h | | | |
| 0289h | | | |
| 028Ah | | | |
| 028Bh | | | |
| 028Ch | | | |
| 028Dh | | | |
| 028Eh | | | |
| 028Fh | | | |
| 0290h | Timer RF Register | TRF | 00h |
| 0291h | | | 00h |
| 0292h | | | |
| 0293h | | | |
| 0293h | | | |
| 0294H 0295h | | | |
| 0295h 0296h | | | |
| 0296h 0297h | | | |
| 029/11 | | | |
| 0298h | | | |
| 0299h | | TDEOD | |
| 029Ah | Timer RF Control Register 0 | TRFCR0 | 00h |
| 029Bh | Timer RF Control Register 1 Capture / Compare 0 Register | TRFCR1 | 00h |
| 029Ch | Capture / Compare 0 Register | TRFM0 | 0000h ⁽²⁾ |
| 029Dh | | | FFFFh ⁽³⁾ |
| 029Eh | Compare 1 Register | TRFM1 | FFh |
| 029Fh | | | FFh |
| 02A0h | | | |
| 02A1h | | | |
| 02A2h | | | |
| 02A3h | | | |
| 02A4h | | | |
| 02A5h | | | |
| 02A6h | | | |
| 02A7h | | | |
| 02A8h | | | |
| 02A9h | | | |
| 02A9II 02AAh | | | |
| | | | |
| 02ABh | | | |
| 02ACh | | | |
| 02ADh | | | |
| 02AEh | | | |
| 02AFh | | | |
| 02B0h | | | |
| 02B1h | | | |
| 02B2h | | | |
| 02B3h | | | |
| 02B4h | | | |
| 02B5h | | | |
| 02B6h | | | |
| 02B7h | | <u> </u> | |
| 02B8h | | | |
| 02B9h | | | |
| 02BAh | | | |
| 02BBh | | | |
| 02BCh | | | |
| 02BDh | | | |
| 02BEh | | | |
| 02BFh | | | |
| <u> </u> | | | |

NOTES:

- The blank regions are reserved. Do not access locations in these regions.
 After input capture mode.
 After output compare mode.

Table 4.12 SFR Information (12)⁽¹⁾

| | , , , , , , , , , , , , , , , , , , , | | 1 |
|---------|---|----------|-------------|
| Address | Register | Symbol | After reset |
| 02C0h | A/D Register 0 | AD0 | XXh |
| 02C1h | | | XXh |
| 02C2h | A/D Register 1 | AD1 | XXh |
| 02C3h | 1 | | XXh |
| 02C4h | A/D Register 2 | AD2 | XXh |
| 02C5h | A/D (Tegister 2 | ADZ | |
| 02C5h | | | XXh |
| 02C6h | A/D Register 3 | AD3 | XXh |
| 02C7h | | | XXh |
| 02C8h | | | |
| 02C9h | | | |
| 02CAh | | | |
| 02CBh | | | |
| | | | |
| 02CCh | | | |
| 02CDh | | | |
| 02CEh | | | |
| 02CFh | | | |
| 02D0h | | | |
| 02D1h | <u> </u> | | |
| 02D1h | | | |
| | | + | + |
| 02D3h | | 1000115 | |
| 02D4h | A/D Control Register 2 | ADCON2 | 00001000b |
| 02D5h | | | |
| 02D6h | A/D Control Register 0 | ADCON0 | 00000011b |
| 02D7h | A/D Control Register 1 | ADCON1 | 00h |
| 02D8h | 74B Goldon Rogiotor 1 | 7.500111 | 0011 |
| | | | |
| 02D9h | | | |
| 02DAh | | | |
| 02DBh | | | |
| 02DCh | | | |
| 02DDh | | | |
| 02DEh | | | |
| 02DFh | | | |
| | | - | |
| 02E0h | Port P7 Direction Register | PD7 | 00h |
| 02E1h | | | |
| 02E2h | Port P7 Register | P7 | XXh |
| 02E3h | | | |
| 02E4h | Port P8 Direction Register | PD8 | 00h |
| | Port D Direction Register | PD9 | X0h |
| 02E5h | Port P9 Direction Register | | |
| 02E6h | Port P8 Register | P8 | XXh |
| 02E7h | Port P9 Register | P9 | XXh |
| 02E8h | | | |
| 02E9h | | | |
| 02EAh | | | |
| 02EBh | | | |
| | | + | |
| 02ECh | | | |
| 02EDh | | | |
| 02EEh | | | |
| 02EFh | | | |
| 02F0h | | 1 | |
| 02F1h | | + | + |
| | | + | |
| 02F2h | | 1 | |
| 02F3h | | | |
| 02F4h | | | |
| 02F5h | | | |
| 02F6h | | 1 | |
| 02F7h | | + | + |
| | | + | + |
| 02F8h | | 1 | |
| 02F9h | | | |
| 02FAh | | | |
| 02FBh | | 1 | |
| 02FCh | Pull-Up Control Register 2 | PUR2 | XXX00000b |
| 02FDh | I all op control hogister z | 1 011/2 | 7.7.00000 |
| | | + | |
| 02FEh | | | |
| 02FFh | Timer RF Output Control Register | TRFOUT | 00h |
| | | | |
| FFFFh | Option Function Select Register | OFS | (Note 2) |
| | , | | 1 \ / |

X: Undefined
NOTES:

1. The blank regions are reserved. Do not access locations in these regions.
2. The OFS register cannot be changed by a program. Use a flash programmer to write to it.

5. Electrical Characteristics

The electrical characteristics of N version (Topr = -20° C to 85° C) and D version (Topr = -40° C to 85° C) are listed below.

Please contact Renesas Technology sales offices for the electrical characteristics in the Y version (Topr = -20° C to 105° C).

Table 5.1 Absolute Maximum Ratings

| Symbol | Parameter | Condition | Rated Value | Unit |
|----------|-------------------------------|-------------|--|------|
| Vcc/AVcc | Supply voltage | | -0.3 to 6.5 | V |
| Vı | Input voltage | | -0.3 to Vcc + 0.3 | V |
| Vo | Output voltage | | -0.3 to Vcc + 0.3 | V |
| Pd | Power dissipation | Topr = 25°C | 700 | mW |
| Торг | Operating ambient temperature | | -20 to 85 (N version) / -40 to 85 (D version) | °C |
| Tstg | Storage temperature | | -65 to 150 | °C |

Recommended Operating Conditions Table 5.2

| Symbol | | Parameter | Conditions | | Standard | | Unit |
|-----------|--------------------------------|--|---|---------|----------|---------|------|
| Symbol | ' | Parameter | Conditions | Min. | Тур. | Max. | Onit |
| Vcc/AVcc | Supply voltage | | | 2.2 | - | 5.5 | V |
| Vss/AVss | Supply voltage | | | - | 0 | _ | V |
| VIH | Input "H" voltage | | | 0.8 Vcc | - | Vcc | V |
| VIL | Input "L" voltage | | | 0 | _ | 0.2 Vcc | V |
| IOH(sum) | Peak sum output "H" current | Sum of all pins IOH(peak) | | - | = | -240 | mA |
| IOH(sum) | Average sum output "H" current | Sum of all pins IOH(avg) | | - | = | -120 | mA |
| IOH(peak) | Peak output "H" | Except P2_0 to P2_7 | | - | - | -10 | mA |
| | current | P2_0 to P2_7 | | - | - | -40 | mA |
| IOH(avg) | Average output | Except P2_0 to P2_7 | | - | - | -5 | mA |
| | "H" current | P2_0 to P2_7 | | - | - | -20 | mA |
| IOL(sum) | Peak sum output "L" current | Sum of all pins IOL(peak) | | - | = | 240 | mA |
| IOL(sum) | Average sum output "L" current | Sum of all pins IOL(avg) | | = | = | 120 | mA |
| IOL(peak) | Peak output "L" | Except P2_0 to P2_7 | | - | _ | 10 | mA |
| | current | P2_0 to P2_7 | | - | - | 40 | mA |
| IOL(avg) | Average output | Except P2_0 to P2_7 | | - | - | 5 | mA |
| | "L" current | P2_0 to P2_7 | | - | _ | 20 | mA |
| f(XIN) | XIN clock input osc | cillation frequency | 3.0 V ≤ Vcc ≤ 5.5 V | 0 | _ | 20 | MHz |
| | | | 2.7 V ≤ Vcc < 3.0 V | 0 | _ | 10 | MHz |
| | | | 2.2 V ≤ Vcc < 2.7 V | 0 | _ | 5 | MHz |
| f(XCIN) | XCIN clock input o | scillation frequency | 2.2 V ≤ Vcc ≤ 5.5 V | 0 | _ | 70 | kHz |
| _ | System clock | OCD2 = 0 | 3.0 V ≤ Vcc ≤ 5.5 V | 0 | _ | 20 | MHz |
| | | XIN clock selected | 2.7 V ≤ Vcc < 3.0 V | 0 | _ | 10 | MHz |
| | | | 2.2 V ≤ Vcc < 2.7 V | 0 | _ | 5 | MHz |
| | | OCD2 = 1 On-chip oscillator clock selected | FRA01 = 0 Low-speed on-chip oscillator clock selected | _ | 125 | _ | kHz |
| | | | FRA01 = 1 High-speed on-chip oscillator clock selected 3.0 V ≤ Vcc ≤ 5.5 V | = | - | 20 | MHz |
| | | | FRA01 = 1 High-speed on-chip oscillator clock selected 2.7 V ≤ Vcc ≤ 5.5 V | _ | - | 10 | MHz |
| | | | FRA01 = 1 High-speed on-chip oscillator clock selected 2.2 V ≤ Vcc ≤ 5.5 V | _ | - | 5 | MHz |

NOTES:

^{1.} Vcc = 2.2 to 5.5 V at Topr = -20 to $85^{\circ}C$ (N version) / -40 to $85^{\circ}C$ (D version), unless otherwise specified.

^{2.} The average output current indicates the average value of current measured during 100 ms.

Table 5.6 Flash Memory (Data flash Block A, Block B) Electrical Characteristics(4)

| Symbol | Parameter | Conditions | | Stand | ard | Unit | |
|------------|---|-----------------------------|--------------------|-------|----------------------------|-------|--|
| Symbol | i didiffetei | Conditions | Min. | Тур. | Max. | | |
| _ | Program/erase endurance ⁽²⁾ | | 10,000(3) | - | - | times | |
| - | Byte program time (program/erase endurance ≤ 1,000 times) | | - | 50 | 400 | μS | |
| _ | Byte program time (program/erase endurance > 1,000 times) | | - | 65 | _ | μS | |
| _ | Block erase time (program/erase endurance ≤ 1,000 times) | | - | 0.2 | 9 | S | |
| - | Block erase time (program/erase endurance > 1,000 times) | | - | 0.3 | - | S | |
| td(SR-SUS) | Time delay from suspend request until suspend | | _ | - | 97+CPU clock × 6 cycles | μS | |
| _ | Interval from erase start/restart until following suspend request | | 650 | = | _ | μS | |
| _ | Interval from program start/restart until following suspend request | | 0 | - | _ | ns | |
| _ | Time from suspend until program/erase restart | | - | - | 3+CPU clock × 4 cycles | μS | |
| - | Program, erase voltage | | 2.7 | - | 5.5 | V | |
| - | Read voltage | | 2.2 | ı | 5.5 | V | |
| = | Program, erase temperature | | -20 ⁽⁸⁾ | - | 85 | °C | |
| - | Data hold time ⁽⁹⁾ | Ambient temperature = 55 °C | 20 | - | - | year | |

NOTES:

- 1. Vcc = 2.7 to 5.5 V at Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.
- 2. Definition of programming/erasure endurance
 - The programming and erasure endurance is defined on a per-block basis.

If the programming and erasure endurance is n (n = 100 or 10,000), each block can be erased n times. For example, if 1,024 1-byte writes are performed to block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one.

However, the same address must not be programmed more than once per erase operation (overwriting prohibited).

- 3. Endurance to guarantee all electrical characteristics after program and erase. (1 to Min. value can be guaranteed).
- 4. Standard of block A and block B when program and erase endurance exceeds 1,000 times. Byte program time to 1,000 times is the same as that in program ROM.
- 5. In a system that executes multiple programming operations, the actual erasure count can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. It is also advisable to retain data on the erase count of each block and limit the number of erase operations to a certain number.
- 6. If an error occurs during block erase, attempt to execute the clear status register command, then execute the block erase command at least three times until the erase error does not occur.
- 7. Customers desiring program/erase failure rate information should contact their Renesas technical support representative.
- 8. –40°C for D version.
- 9. The data hold time includes time that the power supply is off or the clock is not supplied.

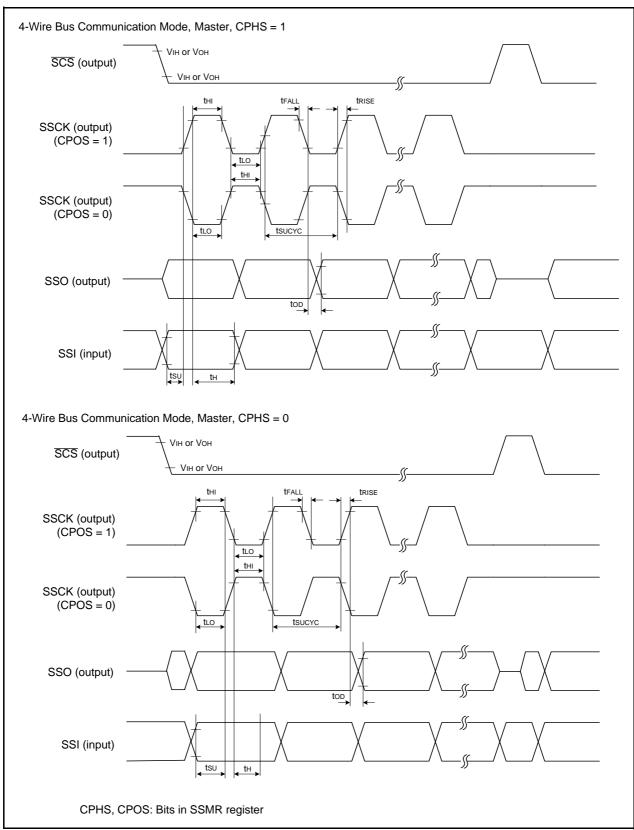


Figure 5.4 I/O Timing of Clock Synchronous Serial I/O with Chip Select (Master)

Table 5.23 Electrical Characteristics (3) [Vcc = 3 V]

| Symbol | Parameter | | Condition | | Standard | | | Unit |
|------------------------|---------------------|--|------------------------|---------------|-----------|------|------|------|
| Symbol | | | | | Min. | Тур. | Max. | Unit |
| Vон | Output "H" voltage | Except P2_0 to P2_7, XOUT | IOH = −1 mA | | Vcc - 0.5 | = | Vcc | V |
| | | P2_0 to P2_7 | Drive capacity HIGH | lон = −5 mA | Vcc - 0.5 | = | Vcc | V |
| | | | Drive capacity LOW | lон = −1 mA | Vcc - 0.5 | - | Vcc | V |
| | | XOUT | Drive capacity HIGH | lон = −0.1 mA | Vcc - 0.5 | - | Vcc | V |
| | | | Drive capacity LOW | IOH = -50 μA | Vcc - 0.5 | - | Vcc | V |
| VoL Output "L" voltage | Output "L" voltage | Except P2_0 to P2_7, XOUT | IoL = 1 mA | | = | - | 0.5 | V |
| | | P2_0 to P2_7 | Drive capacity HIGH | IoL = 5 mA | = | - | 0.5 | V |
| | | | Drive capacity LOW | IoL = 1 mA | = | = | 0.5 | V |
| | | XOUT | Drive capacity HIGH | IoL = 0.1 mA | = | = | 0.5 | V |
| | | | Drive capacity LOW | IOL = 50 μA | = | = | 0.5 | V |
| VT+-VT- | Hysteresis | INTO, INT1, INT2, INT3, KIO, KI1, KI2, KI3, TRAIO, TRFI, RXDO, RXD1, CLKO, CLK1, CLK2, SSI, SCL, SDA, SSO | | | 0.1 | 0.3 | _ | V |
| | | RESET | | | 0.1 | 0.4 | = | V |
| Iн | Input "H" current | 1 - | VI = 3 V | | _ | _ | 4.0 | μА |
| lı∟ | Input "L" current | | VI = 0 V | | - | _ | -4.0 | μA |
| RPULLUP | Pull-up resistance | | VI = 0 V | | 66 | 160 | 500 | kΩ |
| RfXIN | Feedback resistance | XIN | | | _ | 3.0 | _ | ΜΩ |
| RfXCIN | Feedback resistance | XCIN | | | _ | 18 | - | ΜΩ |
| VRAM | RAM hold voltage | • | During stop mod | le | 1.8 | - | - | V |

NOTE

^{1.} Vcc = 2.7 to 3.3 V at Topr = -20 to $85^{\circ}C$ (N version) / -40 to $85^{\circ}C$ (D version), f(XIN) = 10 MHz, unless otherwise specified.

Table 5.24 Electrical Characteristics (4) [Vcc = 3 V] (Topr = -20 to 85° C (N version) / -40 to 85° C (D version), unless otherwise specified.)

| Symbol | Parameter | | Condition | | Standar | | Unit |
|--------|--|--|--|------|---------|------|------|
| | | | | Min. | Тур. | Max. | |
| lcc | Power supply current (Vcc = 2.7 to 3.3 V) Single-chip mode, output pins are open, | High-speed clock mode | XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division | - | 5.5 | _ | mA |
| | other pins are Vss | | XIN = 10 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8 | _ | 2 | _ | mA |
| | | High-speed on-chip oscillator | XIN clock off High-speed on-chip oscillator on fOCO = 10 MHz Low-speed on-chip oscillator on = 125 kHz No division | - | 5.5 | 11 | mA |
| | | mode | XIN clock off High-speed on-chip oscillator on fOCO = 10 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8 | _ | 2.2 | _ | mA |
| | | Low-speed on-chip oscillator mode | XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8, FMR47 = 1 | _ | 145 | 400 | μА |
| | | Low-speed clock mode | XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz FMR47 = 1 | - | 145 | 400 | μΑ |
| | | | XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz Program operation on RAM Flash memory off, FMSTP = 1 | _ | 30 | _ | μА |
| | | Wait mode | XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = VCA25 = 0 VCA20 = 1 | _ | 28 | 85 | μА |
| | | | XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = VCA25 = 0 VCA20 = 1 | = | 17 | 50 | μΑ |
| | | | XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (high drive) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0 VCA20 = 1 | _ | 3.3 | _ | μА |
| | | | XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (low drive) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0 VCA20 = 1 | = | 2.1 | = | μА |
| | | Stop mode | XIN clock off, Topr = 25°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0 | _ | 0.65 | 3.0 | μΑ |
| | | | XIN clock off, Topr = 85°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0 | = | 1.65 | | μА |

Table 5.31 Electrical Characteristics (6) [Vcc = 2.2 V] (Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.)

| Symbol | Parameter | | Condition | | Standard | | Unit |
|--------|--|--|--|------|----------|------|------|
| | | | | Min. | Тур. | Max. | |
| Icc | Power supply current (Vcc = 2.2 to 2.7 V) Single-chip mode, output pins are open, | High-speed clock mode | XIN = 5 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz No division | _ | 2.5 | _ | mA |
| | other pins are Vss | | XIN = 5 MHz (square wave) High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8 | - | 1 | _ | mA |
| | | High-speed on-chip oscillator | XIN clock off High-speed on-chip oscillator on fOCO = 5 MHz Low-speed on-chip oscillator on = 125 kHz No division | - | 4 | = | mA |
| | | mode | XIN clock off High-speed on-chip oscillator on fOCO = 5 MHz Low-speed on-chip oscillator on = 125 kHz Divide-by-8 | _ | 1.7 | _ | mA |
| | | Low-speed on- chip oscillator mode | XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz Divide-by-8, FMR47 = 1 | - | 110 | 300 | μА |
| | | Low-speed clock mode | XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz FMR47 = 1 | _ | 125 | 350 | μА |
| | | | XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz Program operation on RAM Flash memory off, FMSTP = 1 | П | 27 | - | μА |
| | | Wait mode | XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock operation VCA27 = VCA26 = VCA25 = 0 VCA20 = 1 | _ | 20 | 60 | μА |
| | | | XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator on = 125 kHz While a WAIT instruction is executed Peripheral clock off VCA27 = VCA26 = VCA25 = 0 VCA20 = 1 | _ | 12 | 40 | μА |
| | | | XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (high drive) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0 VCA20 = 1 | _ | 2.8 | - | μА |
| | | | XIN clock off High-speed on-chip oscillator off Low-speed on-chip oscillator off XCIN clock oscillator on = 32 kHz (low drive) While a WAIT instruction is executed VCA27 = VCA26 = VCA25 = 0 VCA20 = 1 | = | 1.9 | = | μА |
| | | Stop mode | XIN clock off, Topr = 25°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0 | | 0.6 | 3.0 | μА |
| | | | XIN clock off, Topr = 85°C High-speed on-chip oscillator off Low-speed on-chip oscillator off CM10 = 1 Peripheral clock off VCA27 = VCA26 = VCA25 = 0 | = | 1.60 | = | μА |

Timing requirements

(Unless Otherwise Specified: Vcc = 2.2 V, Vss = 0 V at Topr = 25°C) [Vcc = 2.2 V]

Table 5.32 XIN Input, XCIN Input

| Symbol | Parameter | Stan | Unit | |
|-----------|-----------------------|------|------|-------|
| | Falametei | | Max. | Offic |
| tc(XIN) | XIN input cycle time | 200 | = | ns |
| twh(xin) | XIN input "H" width | 90 | = | ns |
| tWL(XIN) | XIN input "L" width | 90 | = | ns |
| tc(XCIN) | XCIN input cycle time | 14 | = | μS |
| twh(xcin) | XCIN input "H" width | 7 | = | μS |
| tWL(XCIN) | XCIN input "L" width | 7 | = | μS |

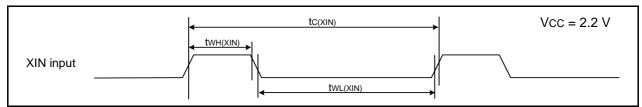


Figure 5.18 XIN Input and XCIN Input Timing Diagram when Vcc = 2.2 V

Table 5.33 TRAIO Input, INT1 Input

| Symbol | Parameter | Stan | Unit | |
|------------|------------------------|------|------|-------|
| | raidilletei | Min. | Max. | Offic |
| tc(TRAIO) | TRAIO input cycle time | 500 | - | ns |
| tWH(TRAIO) | TRAIO input "H" width | 200 | = | ns |
| tWL(TRAIO) | TRAIO input "L" width | 200 | _ | ns |



Figure 5.19 TRAIO Input and $\overline{\text{INT1}}$ Input Timing Diagram when Vcc = 2.2 V

Table 5.34 TRFI Input

| Symbol | Parameter | Stan | Unit | |
|-----------|-----------------------|---------|------|-------|
| | raidilletei | Min. | Max. | Offic |
| tc(TRFI) | TRFI input cycle time | 2000(1) | - | ns |
| twh(TRFI) | TRFI input "H" width | 1000(2) | - | ns |
| twl(TRFI) | TRFI input "L" width | 1000(2) | - | ns |

NOTES:

- 1. When using timer RF input capture mode, adjust the cycle time to (1/timer RF count source frequency × 3) or above.
- 2. When using timer RF input capture mode, adjust the pulse width to (1/timer RF count source frequency × 1.5) or above.

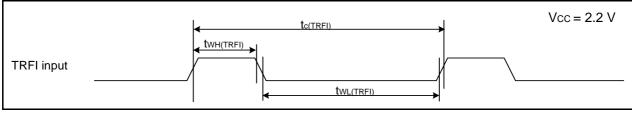


Figure 5.20 TRFI Input Timing Diagram when Vcc = 2.2 V